



Industry meets Industry Workshop I :

Optimising interaction between components, material and equipment manufacturers

Tuesday 4 September 2007
LEM 3 – Milano Fiera

Agenda

Moderator: Winfried Hoffmann, EPIA President & CTO Applied Materials

14:30 – 15:30 *Learning from the semiconductor industry*

- Industry Point of View - EPIA President & CTO Applied Materials
- Research Point of View - Jef Poortmans, IMEC
- Potential of interactions - PERFORMANCE Project - Christian Reise, Fraunhofer Institute

15:30 – 16:30 *Component manufacturers addressing equipment manufacturers*

With representatives from:

Equipment manufacturers:

- Applied Materials (Winfried Hoffman)
- Oerlikon (Detlef Koch-Ospelt)
- Centrotherm photovoltaics (representative t.b.d.)
- Roth & Rau (Bernd Rau)

Component manufacturers:

- Wafer: SolarWorld (Boris Klebensberger)
- Cells: Q-Cells (Florian Holzapfel)
- Module: Solon AG (Kai Siemer)
- Thin Film: Shell Avancis (Franz Karg)

Short statement from each representant of the value-chain
Discussion

16:30 – 17:30 *Component manufacturers addressing material suppliers*

With representatives from:

Component manufacturers:

- Wafer: PV Silicon (Hubert Aulich)
- Cells: China Sunergy (Jinhua Zhao)
- Module: Solarwatt (Frank Schneider)
- Thin-Film: Würth Solar (Bernhard Dimmler)

Material Suppliers:

- Isovolta (Albert Plessing)
- August Krempel Soehne (Karlheinz Brust)
- Hemlock (Luc vanCotthem)
- Saint-Gobain (Alain Garnier)

Short statement from each representant of the value-chain
Discussion

17:30 *End of Meeting*

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